

NPN PRE-BIASED SMALL SIGNAL DUAL SURFACE MOUNT TRANSISTOR

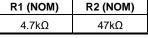
Features

- **Epitaxial Planar Die Construction**
- **Built-In Biasing Resistors**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

R1 (NOM)	R2 (NOM)
4.7kΩ	47kΩ

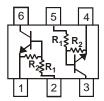
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208@3
- Weight: 0.006 grams (Approximate)





Top View



Device Schematic

Ordering Information (Note 5)

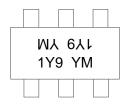
Part Number	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
ADC143ZUQ-7	Automotive	1Y9	7	8	3,000
ADC143ZUQ-13	Automotive	1Y9	13	8	10,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/product-compliance-definitions/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information





1Y9 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: E = 2017)M = Month (ex: 9 = September)

Date Code Key

Year	2017	2018	2019	2020	202	21 20)22	2023	2024	2025	2026	2027
Code	Е	F	G	Н	- 1		J	K	L	M	N	0
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Supply Voltage	Vcc	50	V
Input Voltage	V _{IN}	-5 to +30	V
Output Current	I _{C(MAX)}	100	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

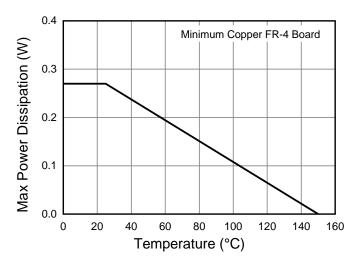
Characteristic	Symbol	Value	Unit
Power Dissipation (Notes 6 & 7)	P_{D}	270	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	$R_{ hetaJA}$	450	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

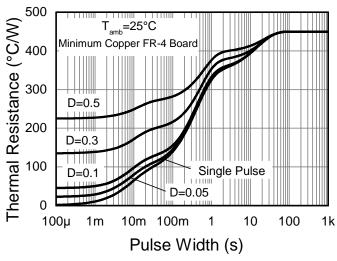
^{6.} Mounted on FR-4 PC Board with minimum recommended pad layout. 7. 150mW per element must not be exceeded.



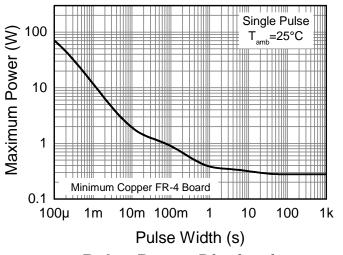
Thermal Characteristics and Derating Information



Derating Curve



Transient Thermal Impedance



Pulse Power Dissipation



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

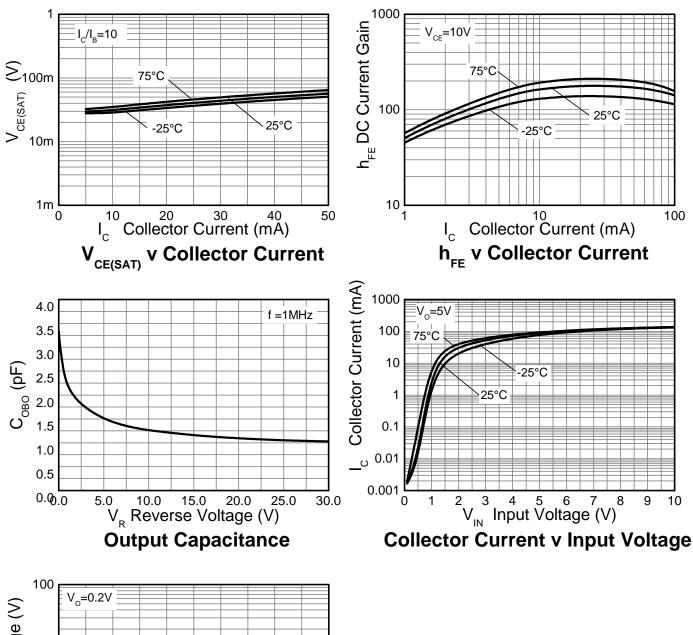
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Input Voltage	V _{I(OFF)} (Note 8)	0.5	_	_	V	$V_{CC} = 5V, I_{O} = 100\mu A$
Imput voltage	V _{I(ON)} (Note 9)	_	_	1.3	V	$V_O = 0.3V, I_O = 5mA$
Output Voltage	$V_{O(ON)}$		0.1	0.3	V	$I_0/I_1 = 5mA / 0.25mA$
Input Current	II		_	1.8	mA	$V_I = 5V$
Output Current	I _{O(OFF)}	_	_	0.5	μΑ	$V_{CC} = 50V, V_{I} = 0V$
DC Current Gain	G _I	80	_	_		$V_O = 5V, I_O = 10mA$
Input Resistor (R ₁) Tolerance	ΔR_1	-30	_	+30	%	_
Resistance Ratio Tolerance	$\Delta(R_2/R_1)$	-20	_	+20	%	_
Gain-Bandwidth Product (Note 10)	f _T	_	250	_	MHz	$V_{CE} = 10V$, $I_{E} = 5mA$, $f = 100MHz$

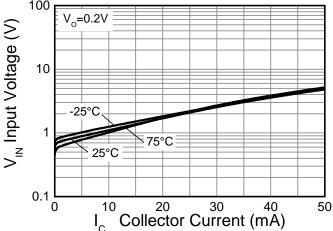
Notes:

- Guarantees that the device will be switched OFF if the Input Voltage is less than 0.5V.
 Guarantees that the device will be switched ON if the Input Voltage is more than 1.3V.
 Transistor For Reference Only.



Typical Electrical Characteristics (@TA = +25°C, unless otherwise specified.)





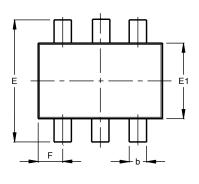
Input Voltage v Collector Current

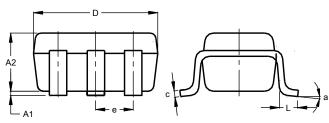


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



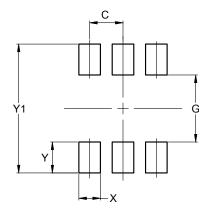


SOT363						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	1.00			
b	0.10	0.30	0.25			
С	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	C).650 B	SC			
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2 500



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